

Features

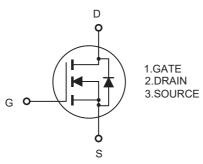
- · High Current Rating
- Lower R_{DS(ON)}
- · Lower Capacitance
- Lower Total Gate Charge
- Tighter V_{SD} Specifications
- · Avalanche Energy Specified
- · Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free Available Upon Request By Adding Suffix "-HF"

Maximum Ratings

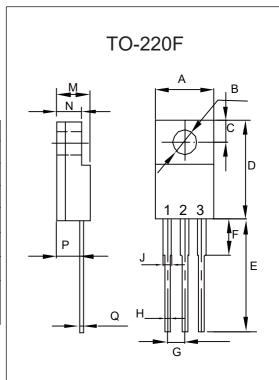
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 62.5°C/W Junction to Ambient

Parameter	Symbol	Rating	Unit
Drain -Source Voltage	V _{DS}	650	V
Gate -Source Volltage	V_{GS}	±30	V
Drain Current-Continuous	I _D	12.0	Α
Drain Current-Pulse ^(Note4)	I _{DM}	48	Α
Power Dissipation	P _D	2.0	W
Single Pulsed Avalanche Energy ^(note 1)	E _{AS}	540	mJ
Maximum Lead Temperure for Soldering Purposes,1/8" from Case for 5 Seconds	T _L	260	°C

Internal Structure



N-Channel Enhancement Mode Field Effect Transistor



	DIMENSIONS					
DIM	INCHES		MM		NOTE	
Dilvi	MIN	MAX	MIN	MAX	NOTE	
Α	0.392	0.421	9.96	10.70		
В	0.1	38	3.5	50	Ф	
С	0.1	06	2.70		TYP.	
D	0.567	0.642	14.40	16.30		
Е	0.520		13.20		TYP.	
F		0.177		4.50		
G	0.1	00	2.	54	TYP.	
Н	0.020	0.035	0.50	0.90		
J	0.043	0.053	1.10	1.35		
M	0.169	0.201	4.30	5.10		
N		0.140		3.56		
Р	0.083	0.126	2.10	3.20		
Q	0.020	0.032	0.50	0.80		



Electrical Characteristics @ 25°C (Unless Otherwise Noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$				
Drain-Source Diode Forward Voltage ^(note2)	V _{SD}	V _{GS} =0V, I _S =12.0A			1.4	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V			1.0	μΑ
Gate-Body Leakage Current, Forward ^(note2)	I _{GSSF}	V _{DS} =0V, V _{GS} =30V			100	nA
Gate-Body Leakage Current, Reverse ^(note2)	I _{GSSR}	V _{DS} =0V, V _{GS} =-30V			-100	
On Characteristics(note2)						
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0	3.5	4.0	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =6A		0.7	0.85	Ω
Dynamic Characteristics(note 3)						
Input Capacitance	C _{iss}			1800		
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V,f=1MHz		200		pF
Reverse Transfer Capacitance	C _{rss}			25		
Switching characteristics(note2,3,4)	1	I				
Total Gate Charge	Q_g			42	5	0
Gate-Source Charge	Q_{gs}	V _{DS} =520V,V _{GS} =10V,I _D =12A		8.6		_ nC
Gate-Drain Charge	Q_{gd}			21		
Turn-On Delay Time(note 3)	t _{d(on)}	V _{DD} =325V,V _{GS} =10V,		30		
Turn-On Rise Time(note 3)	t _r			90		
Turn-Off Delay Time(note 3)	t _{d(off)}	$R_{G}=25\Omega, I_{D}=12.0A$		160		ns -
Turn-Off Fall Time(note 3)	t _f			90		
Drain-Source Diode Characteristics		1				
Maximum Continuous Drain-source Diode Forward Current	Is				12	Α
Maximum Pulsed Drain-source Diode Forward Current	I _{SM}				48	А

Notes:

- 1. L=7.5mH, I_L =12A, V_{DD} =50V, R_G =25 Ω , Starting T_J =25°C.
- 2. Pulse Test : Pulse width $\!\!\!\! \leqslant\! 300\mu s,$ duty cycle $\!\!\! \leqslant\! \! 2\%.$
- 3. These parameters have no way to verify.
- 4. Pulse width limited by maximum junction temperature



Curve Characteristics

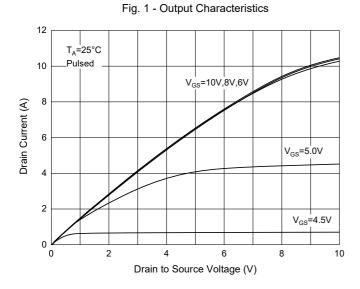


Fig. 2 - Transfer Characteristics

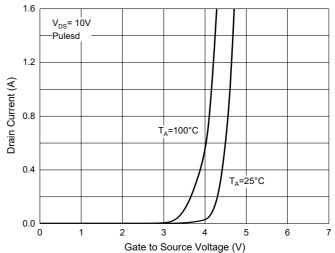


Fig. 3 - R_{DS(ON)}—I_D

1.2

1.0

0.8

V_{GS}=10V

0.6

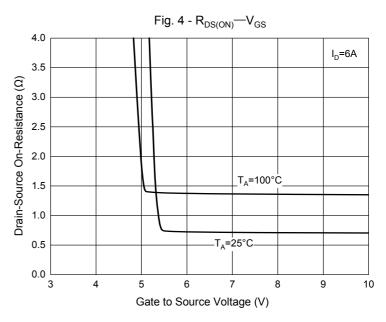
0.0

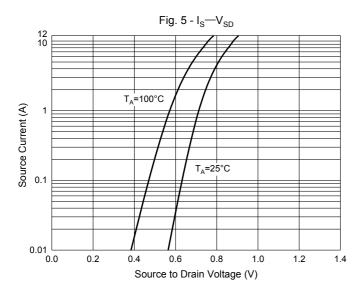
0.2

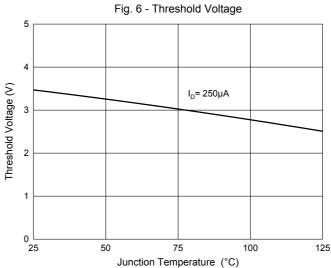
0.0

0 2 4 6 8 10 12

Drain Current (A)









Ordering Information

Device	Packing
Part Number-BP	Bulk:1Kpcs/Box

Note: Adding "-HF" Suffix For Halogen Free, eg. Part Number-BP-HF

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